| Ref # | Hits | Search Query | DBs | Default Operator | Plurals | Time Stamp |
|----------|---------|-------------------------------------|---|---------------------|---------|------------------|
| L1 | 3001389 | substrate or wafer or semiconductor | US-PGPUB; USPAT; EPO; JPO; DERWENT | OR | ON | 2005/09/13 14:11 |
| L2 | 58008 | l1 near6 (damage or failure) | US-PGPUB; USPAT; EPO; JPO; DERWENT | OR | ON | 2005/09/13 14:13 |
| L3 | 52921 | holding adj member | US-PGPUB; USPAT; EPO; JPO; DERWENT | OR | ON | 2005/09/13 14:13 |
| L4 | 1765845 | l3 or head | US-PGPUB; USPAT; EPO; JPO; DERWENT | OR | ON | 2005/09/13 14:14 |
| L5 | 109714 | l4 same l1 | US-PGPUB; USPAT; | OR | ON | 2005/09/13 14:37 |
| 1 | | r Na | EPO; JPO; DERWENT | | | |
| L6 | 5120 | I5 and I2 | US-PGPUB; USPAT; EPO; JPO; DERWENT | OR | ON | 2005/09/13 14:38 |
| L7 | 1752 | l6 and polish\$3 | US-PGPUB; USPAT; EPO; JPO; | OR | ON | 2005/09/13 14:38 |
| | * | | DERWENT | | | |
| L8 | 94318 | sensor near6 (first and second) | US-PGPUB; USPAT; EPO; JPO; DERWENT | OR | ON | 2005/09/13 14:39 |
| L9 | 70 | I7 and I8 | US-PGPUB; USPAT; EPO; JPO; DERWENT | OR - | ON | 2005/09/13 14:40 |
| L10 | 69 | l9 and (detect\$3 or sensing) | US-PGPUB; USPAT; EPO; JPO; DERWENT | OR | ON | 2005/09/13 14:41 |